

Title (en)

STRUCTURE COMPRISING AT LEAST TWO INTEGRATED MICROCIRCUIT DEVICES WITH CONTACTLESS COMMUNICATION

Title (de)

STRUKTUR MIT MINDESTENS ZWEI INTEGRIERTEN MIKROSCHALTUNGEN MIT KONTAKTLOSER KOMMUNIKATION

Title (fr)

STRUCTURE COMPORTANT AU MOINS DEUX DISPOSITIFS A MICROCIRCUIT INTEGRE A COMMUNICATION SANS CONTACT

Publication

EP 2335226 A1 20110622 (FR)

Application

EP 09812765 A 20090907

Priority

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- FR 0856141 A 20080912

Abstract (en)

[origin: WO2010029489A1] The invention relates to a structure (1) comprising at least two separate integrated microcircuit devices with contactless communication, each comprising at least one chip (2, 3) and at least one antenna (5), said at least two integrated microcircuit devices being placed in or on the structure (1) such that any simultaneous reading of more than one of the integrated microcircuit devices by an external reader is impossible in at least one position of the structure (1) relative to the external reader.

IPC 8 full level

G07D 7/00 (2006.01); **G06K 19/077** (2006.01)

CPC (source: EP US)

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Citation (search report)

See references of WO 2010029489A1

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Designated extension state (EPC)

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DOCDB simple family (publication)

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